



Features

- For surface mounted applications in order to optimize board space
- Low profile package
- Built-in strain relief
- Glass passivated junction
- Low inductance
- Excellent clamping capability
- 400W peak pulse power capability at 10/1000 μ s waveform,
- Repetition rate (duty cycle): 0.01%
- Fast response time
- Typical IR less than 1 μ A above 10V
- High Temperature soldering: 260°C/10 seconds at terminals
- Plastic package has underwriters laboratory flammability 94V-0



SMA
(DO-214AC)

Mechanical Data

- Case: JEDEC DO-214AC/SMA molded plastic body
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Polarity symbol marking on body
- Mounting Position: Any
- Weight: 0.07 grams

Applications

- I/O interface
- AC/DC power supply
- Low frequency signal transmission line (RS232, RS485, etc.)

Maximum Ratings (Ta=25°C unless otherwise noted)

Peak pulse power dissipation at 10/1000 μ s waveform (Note1, Note2, Fig.1)	P _{PPM}	400	W
Peak pulse current of at 10/1000 μ s waveform (Note 1, Fig.3)	I _{PPM}	43.5	A
Steady state power dissipation at T _A =50°C (Fig.5)	P _{M(AV)}	3.3	W
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load, (JEDEC Method) (Note3, Fig.6)	I _{FSM}	40	A
Operating junction and Storage Temperature Range.	T _J , T _{STG}	-65 to +150	°C
Typical thermal resistance junction to lead	R _{θJL}	30	°C/W
Typical thermal resistance junction to ambient	R _{θJA}	120	°C/W

Notes:1. Non-repetitive current pulse, per Fig.3 and derated above TA=25°C per Fig.2.

2. Mounted on 5.0mm×5.0mm (0.03mm thick) copper pads to each terminal.

3. 8.3ms single half sine-wave, or equivalent square wave, duty cycle=4 pulses per minutes maximum.

Electrical Characteristics (Ta=25°C)

Part Number		Device Marking Code		Reverse Stand- Off Voltage	Breakdown Voltage @I _T	Test Current	Maximum Clamping Voltage @I _{PP}	Peak Pulse Current	Reverse Leakage @V _{RWM}
Unidirectional	Bidirectional	UNI	BI	V _{RWM} (V)	V _{BR} (V)	I _T (mA)	V _C (V)	I _{PP} (A)	I _R (μ A)
SMAJ5.0A/TR13	SMAJ5.0CA/TR13	AE	WE	5.0	6.40-7.00	10	9.2	43.5	800



Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1. Peak Pulse Power Rating Curve

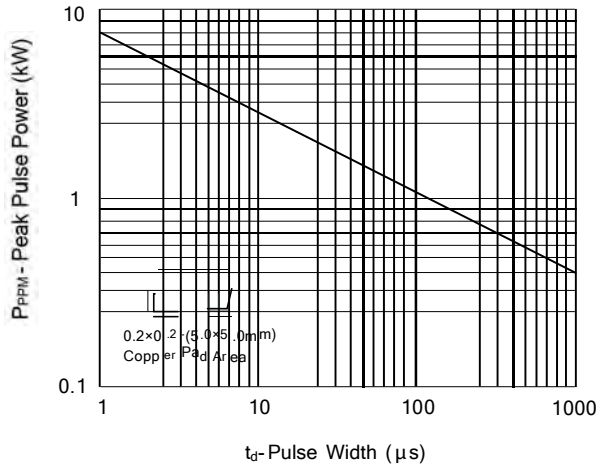


Figure 2. Pulse Derating Curve

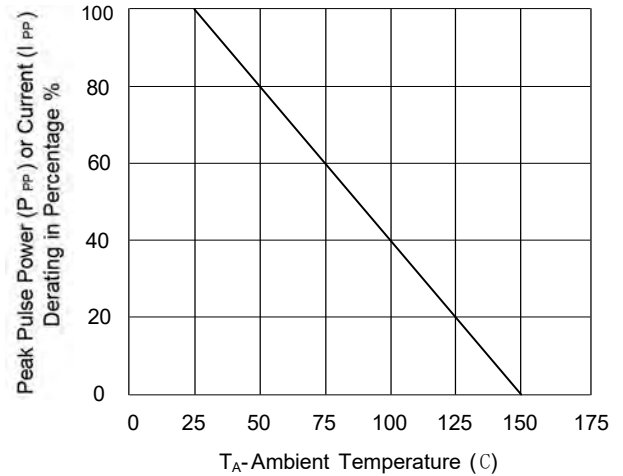


Figure 3. Pulse Waveform

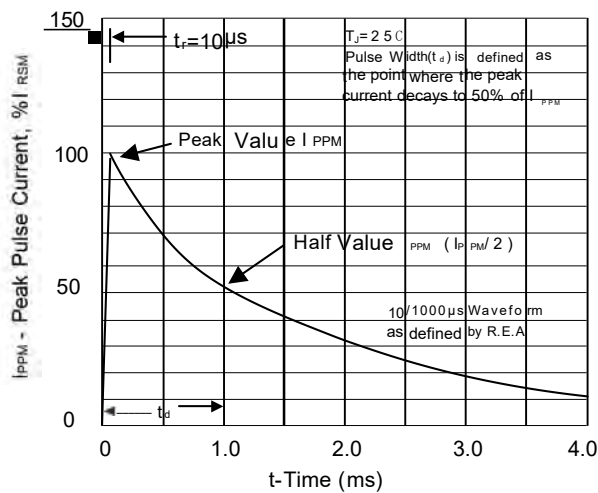


Figure 5. Steady State Power Dissipation Derating Curve

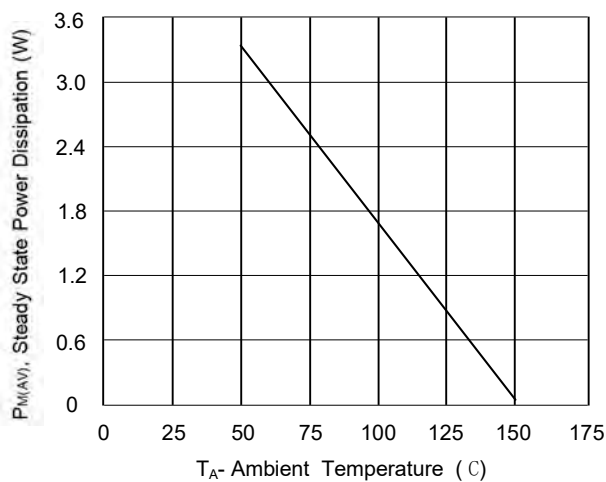


Figure 4. Typical Junction Capacitance

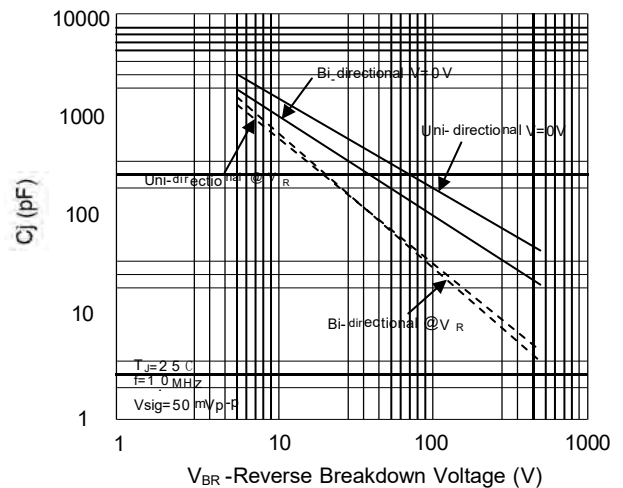
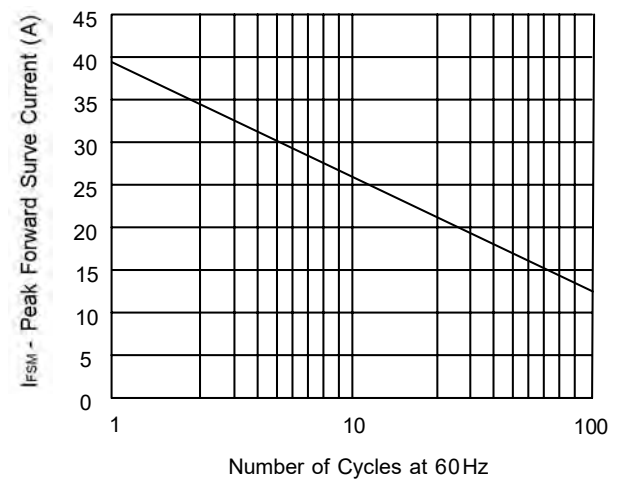


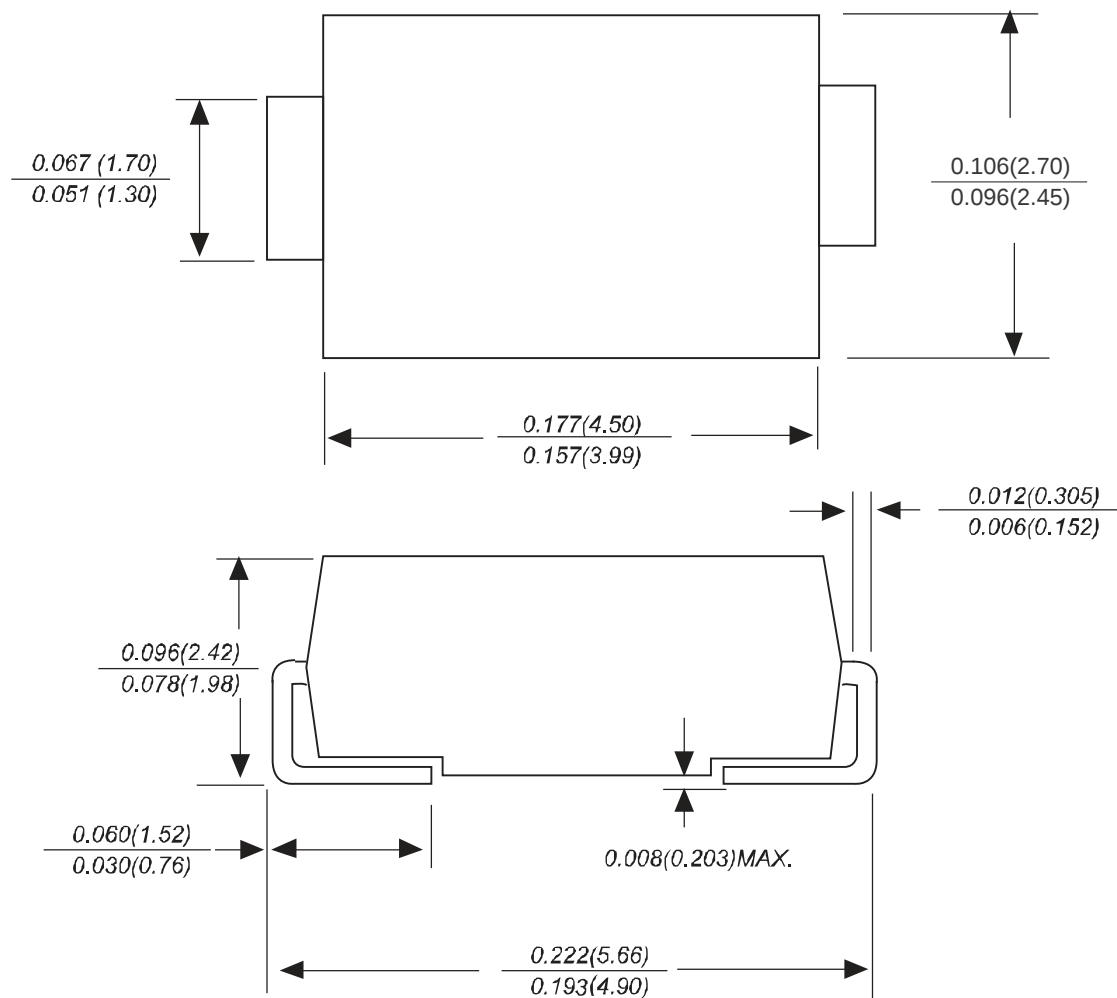
Figure 6. Maximum Non-Repetitive Forward Surge Current Uni-Directional Only





Package Outline Dimensions

SMA(DO-214AC)



Dimensions in inches and (millimeters)



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